

OLED DISPLAY MODULE

Product Specification

CUSTOMER	Standard	
PRODUCT NUMBER	DD-12864WO-3A	
CUSTOMER APPROVAL		Date

INTERNAL APPROVALS					
Product Mgr Doc. Control Electr. Eng					
Elijah	Bazile	Luo			
Ebo	Peter	Luo			



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REVISION RECORD

Rev.	Date	Page	Chapt.	Comment	ECR no.
A	12 Feb 10			First Issue	
В	04 Jul 11		3.1	Changes of Absolute Maximum Ratings	
С	28 Nov 12	27	10	Move chapter 8 to chapter 10	

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1 MAIN FEATURES

ITEM	CONTENTS
Display Format	128 x 64 Dots
Overall Dimensions	45.24 x 29.14 x 2.00 mm
Colour	Monochrome White
Active Area	35.056 x 17.52 mm
Viewing Area	37.056 x 19.52 mm
Display Mode	Passive Matrix (1.54")
Driving Method	1/64 duty
Driver IC	SSD1305
Operating temperature	-30 ~ +70
Storage temperature	-40 ~ +85

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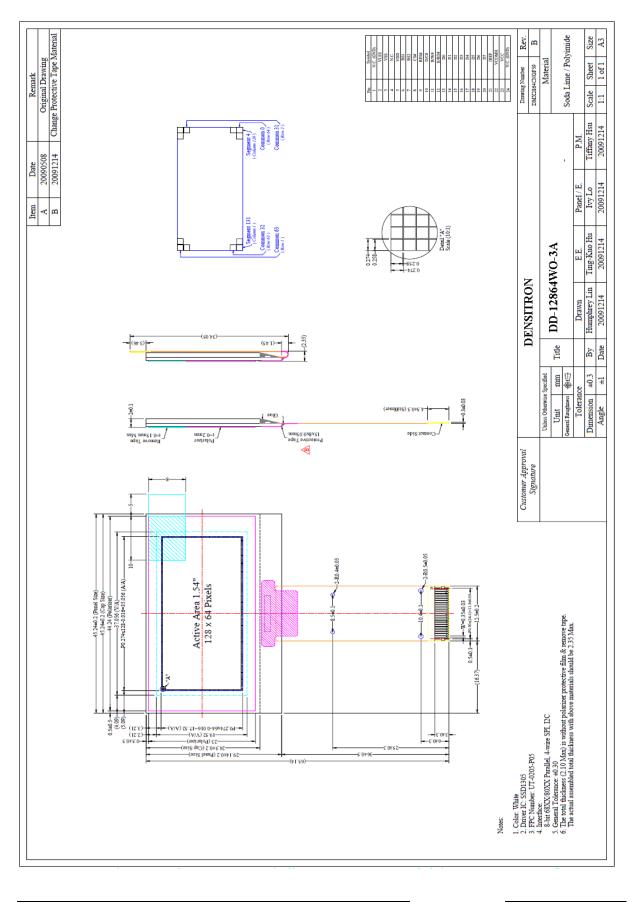
2 MECHANICAL SPECIFICATION

2.1 MECHANICAL CHARACTERISTICS

ITEM	CHARACTERISTIC	UNIT
Display Format	128 x 64 Dots	Dots
Overall Dimensions	45.24 x 29.14 x 2.00	mm
Viewing Area	37.056 x 19.52	mm
Active Area	35.056 x 17.52	mm
Dot Size	0.258 x 0.258	mm
Dot Pitch	0.274 x 0.274	mm
Weight	5.15	g
IC Controller/Driver	SSD1305	

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2.2 MECHANICAL DRAWING



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3 ELECTRICAL SPECIFICATION

3.1 ABSOLUTE MAXIMUM RATINGS

		1		VSS =	$0 \text{ V}, \text{ Ta} = 25 \circ$
Item	Symbol	Min	Max	Unit	Note
Supply Voltage for logic	V _{DD}	-0.3	4.0	V	1.2
Supply voltage for Display	Vcc	0	15	V	1, 2
Operating Temperature	Тор	-40	85	°C	3
Storage Temperature	Tst	-40	90	°C	3
Life Time (120 cd/m ²)		10,000	-	Hour	4
Life Time (80 cd/m ²)		30,000	-	Hour	4
Life Time (60 cd/m ²)		50,000	-	Hour	4
Static Electricity	Be sure t	hat you are g	rounded w	hen handlin	g displays.

Note 1: All the above voltages are on the basis of "VSS=0V".

Note 2: When this module is used beyond the above absolute maximum ratings, permanent damage to the module may occur. Also for normal operations it's desirable to use this module under the conditions according to Section 3.2 "Electrical Characteristics". If this module is used beyond these conditions the module may malfunction and the reliability could deteriorate.

Note 3: The defined temperature ranges do not include the polarizer. The maximum withstood temperature of the polarizer should be 80°C.

Note 4: VCC=12.5V, Ta = 25 °C, 50% Checker board. Software configuration follows Section 5.4 Initialization End of lifetime is specified as 50% of initial brightness reached. The average operating lifetime at room temperature is estimated by the accelerated operation at high temperature conditions.

Characteristics	Symbol	Conditions	Min	Тур	Max	Unit
Supply Voltage	V _{DD}		2.4	2.8	3.5	V
Supply Voltage for Display	Vcc	Note 1	12	12.5	13.0	V
High Level Input	V _{IH}		$0.8 \mathrm{x} \mathrm{V}_\mathrm{DD}$	-	V _{DD}	V
Low Level Input	V _{IL}	IOUT=0.1mA,	0	-	$0.2 \mathrm{x} \mathrm{V}_\mathrm{DD}$	V
High Level Output	V _{OH}	3.3MHz	0.9xVdd	-	Vdd	V
Low Level Output	V _{OL}		0	-	0.1xVdd	V
Operating current for VDD	Idd		-	180	300	μA
		Note 2	-	13,7	17,1	
Operating current for Vcc	Icc	Note 3	-	19,7	24,6	mA
		Note 4	-	27,7	34.,6	
Sleep mode current for VDD	Idd sleep		-	1	5	μΑ
Sleep mode current for Vcc	ICC SLEEP		-	2	10	μA

Note 1: Any change on the Brightness (L_{br}) and Supply Voltage (Vcc) will change the display characteristics.

Note 2: $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 30% display area turned on.

Note 3: $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 50% display area turned on.

Note 3: $V_{DD} = 2.8V$, $V_{CC} = 12.5V$, 100% display area turned on.

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3.3 INTERFACE PIN ASSIGNMENT

No.	Sym	bol	Function			
1	N.C.(G	GND)	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. These pin must be connected to external ground.			
2	VLS	S	Ground of Analog Circuit This is an analog ground pin. It should be connected to VSS externally			
3	VS	S	Ground of Logic circuit This is a ground pin. It also acts as a reference for the logic pins, It must be connected to external ground.			
4	N.C) .	Reserved Pin The N.C. pin between function pins is reserved for compatible and flexible design.			
5	VDI	D	Power Supply for Logic Circuit This is a voltage supply pin. It must be connected to external source.			
6	BS	1	Communicating Protocol Select			
7	BS	2	These pins are MCU interface selection input.68XX-parallel80XX-parallelSerialI2CBS10101BS21100			
8	CS	#	Chip Select This pin is the chip select input. The chip is enabled for MCU communication only when CS# is pulled low.			
9	RES	S#	Power Reset for Controller and Driver This pin is reset signal input. When the pin is low, initialization of the chip is executed.			
10	D/C	:#	Data/Command Control This pin is Data/Command control pin. When the pin is pulled high, the input at D7~D0 is treated as display data. When the pin is pulled low, the input at D7~D0 will be transferred to the command register. For detail relationship to MCU interface signals, please refer to the Timing Characteristics Diagrams. When the pin is pulled high and serial interface mode is selected, the data at SDIN is treated as data. When it is pulled low, the data at SDIN will be transferred to the command register. In I2C mode, this pin acts as SA0 for slave address selection.			
11	R/W	/#	Read/Write Select or Write This pin is MCU interface input. When interfacing to a 68XX-series			
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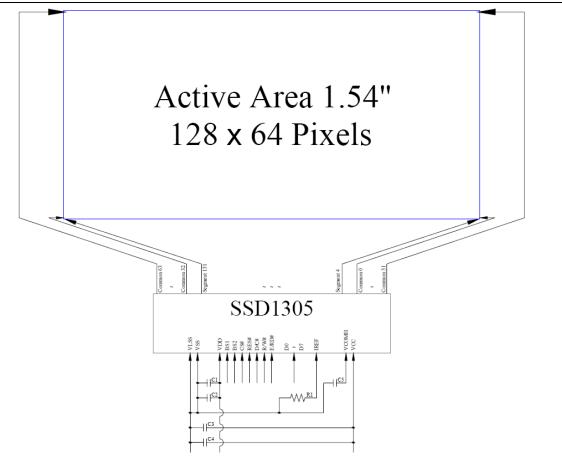


		 microprocessor, this pin will be used as Read/Write (R/W#) selection input. Pull this pin to "High" for read mode and pull it "Low" for write mode. When 80XX interface mode is selected, this pin will be the Write (WR#) input. Data write operation is initiated when this pin is pulled low and the CS# is pulled low.
No.	Symbol	Function
12	E/RD#	Read/Write Enable or Read This pin is MCU interface input. When interfacing to a 68XX-series microprocessor, this pin will be used as the Enable (E) signal. Read/write operation is initiated when this pin is pulled high and the CS# is pulled low. When connecting to an 80XX-microprocessor, this pin receives the Read (RD#) signal. Data read operation is initiated when this pin is pulled low and CS# is pulled low.
13~20	D0~D7	Host Data Input/Output Bus These pins are 8-bit bi-directional data bus to be connected to the microprocessor's data bus. When serial mode is selected, D1 will be the serial data input SDIN and D0 will be the serial clock input SCLK. When I2C mode is selected, D2 & D1 should be tied together and serve as SDAout &SDAin in application and D0 is the serial clock input SCL.
21	IREF	Current Reference for Brightness Adjustment This pin is segment current reference pin. A resistor should be connected between this pin and VSS. Set the current lower than 10uA
22	VCOMH	Voltage Output High Level for COM signal This pin is the input pin for the voltage output high level for COM signals. A capacitor should be connected between this pin and VSS.
23	VCC	Power Supply for OEL Panel This is the most positive voltage supply pin of the chip.
24	N.C.(GND)	Reserved Pin (Supporting Pin) The supporting pin can reduce the influence from stress on the function pins. These pin must be connected to external ground.

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3.4 BLOCK DIAGRAM



MCU Interface Selection: BS1 and BS2 Pins connected to MCU interface: D7~D0, E/RD#, R/W#, D/C#, RES# and CS#.

C1, C3:	0.1µF
C2:	4.7µF
C4:	10µF
C5:	4.7μF/25V Tantalum Capacitor
R1:	910 k Ω , R1 = (Voltage at IREF – BGGND) / IREF

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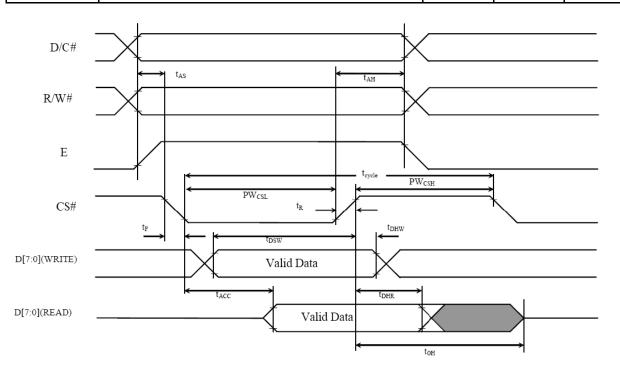
3.5 TIMING CHARACTERISTICS

3.5.1 AC CHARACTERISTICS

3.5.1.1 68XX-Series MPU Parallel Interface Timing Characteristics

VDD-VSS = 2.4V to 3.5V, Ta = $25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	System Cycle Time	300	-	ns
tAS	Address Setup Time	0	-	ns
tAH	Address Hold Time	0	-	ns
tDSW	Write Data Setup Time	40	-	ns
tDHW	Write Data Hold Time	7	-	ns
tDHR	Read Data Hold Time	20	-	ns
tOH	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
PWCSL	Chip Select Low Pulse Width (Read) Chip Select	120		ns
PWCSL	Low Pulse width (Write)	60	1 -	
DWCGU	Chip Select High Pulse Width (Read) Chip Select	60		
PWCSH	High Pulse Width (Write)	60	1 -	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns



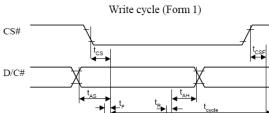
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3.5.1.2 8080-Series MPU Parallel Interface Timing Characteristics

VDD-VSS = 2.4V to 3.5V, Ta = $25^{\circ}C$

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	300	-	ns
tAS	Address Setup Time	10	-	ns
tAH	Address Hold Time	0	-	ns
tDSW	Write Data Setup Time	40	-	ns
tDHW	Write Data Hold Time	7	-	ns
tDHR	Read Data Hold Time	20	-	ns
tOH	Output Disable Time	-	70	ns
tACC	Access Time	-	140	ns
tPWLR	Read Low Time	120	-	ns
tPWLW	Write Low Time	60	-	ns
tPWHR	Read High Time	60	-	ns
tPWHW	Write High Time	60	-	ns
tCS	Chip Select Setup Time	0	-	ns
tCSH	Chip Select Hold Time to Read Signal	0	-	ns
tCSF	Chip Select Hold Time	20	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	-	15	ns

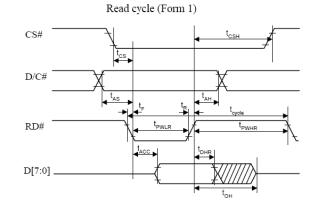


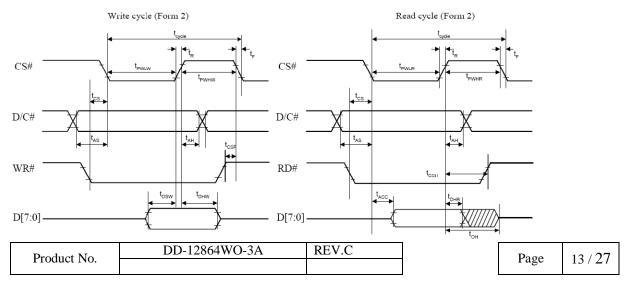
t_{PWLW}

t_{osw}

WR#

D[7:0]

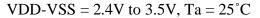


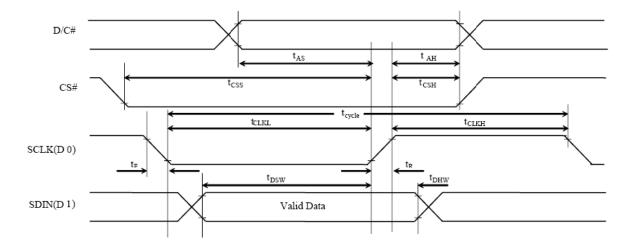


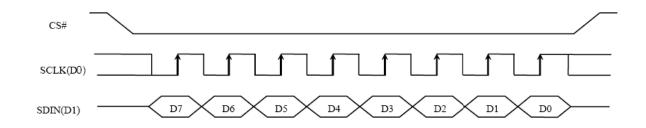


3.5.1.3 Serial Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	250	-	ns
tAS	Address Setup Time	150	-	ns
tAH	Address Hold Time	150	-	ns
tCSS	Chip Select Setup Time	120	-	ns
tCSH	Chip Select Hold Time	60	-	ns
tDSW	Write Data Setup Time	50	-	ns
tDHW	Write Data Hold Time	15	-	ns
tCLKL	Serial Clock Low Time	100	-	ns
tCLKH	Serial Clock High Time	100	-	ns
tR	Rise Time	-	15	ns
tF	Fall Time	_	15	ns





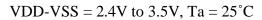


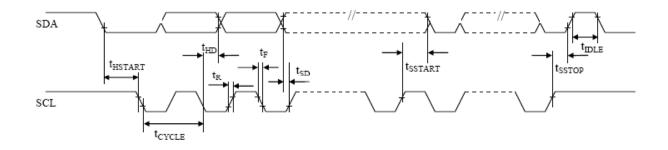
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3.5.1.4 I²C Interface Timing Characteristics

Symbol	Description	Min	Max	Unit
tcycle	Clock Cycle Time	2.5	-	us
tHSTART	Start Condition Hold Time	0.6	-	us
	Data Hold Time (for "SDAOUT" Pin) Data	0		
tHD	Hold Time (for "SDAIN" Pin)	300	-	ns
tSD	Data Setup Time	100	-	ns
	Start Condition Setup Time			
tSSTART	(Only relevant for a repeated Start condition)	0.6	-	us
tSSTOP	Stop Condition Setup Time	0.6	-	us
tR	Rise Time for Data and Clock Pin		300	ns
tF	Fall Time for Data and Clock Pin		300	ns
tIDLE	Idle Time before a New Transmission can Start	1.3	-	us





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4 OPTICAL SPECIFICATION

4.1 OPTICAL CHARACTERISTICS

Characteristics	Symbol	Condition	Min	Тур	Max	Unit
Brightness	L _{br}	Note 1	100	120	-	
C.I.E.(White)	(X)	CLE 1021	0.25	0.29	0.33	cd/m ²
	(Y)	C.I.E. 1931	0.27	0.31	0.35	
Dark Room Contrast	CR		-	>10000:1	-	
Viewing Angle			>160	-	-	degree

Note 1: Any change on the Brightness (L_{br}) and Supply Voltage (Vcc) will change the display characteristics.

Optical measurement taken at $V_{DD} = 2.8V$, $V_{CC} = 12.5V$. Software configuration follows Section 5.4 Initialization

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5 FUNCTIONAL SPECIFICATION

5.1 COMMANDS

Please refer to the Technical Manual for the SSD1305

5.2 POWER UP/DOWN SEQUENCE

To protect panel and extend the panel lifetime, the driver IC power up/down routine should include a delay period between high voltage and low voltage power sources during turn on/off. It gives the panel enough time to complete the action of charge and discharge before/after the operation.

5.2.1 POWER UP SEQUENCE

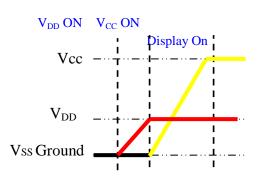
Power up V_{DD}
 Send Display off command
 Initialization
 Clear Screen
 Power up V_{CC}
 Delay 100ms

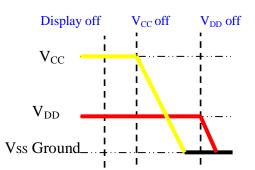
 (when Vcc is stable)
 Send Display on command

5.2.2 POWER DOWN SEQUENCE

- 1. Send Display off command
- 2. Power down V_{CC}
- Delay 100ms

 (When V_{cc} reach 0 and panel is completely discharges)
- 4. Power down V_{DD}





5.3 RESET CIRCUIT

When RES# input is low, the chip is initialized with the following status:

- 1. Display is OFF
- 2. 132x64 Display mode

3. Normal segment and display data colume and row address mapping (SEG0 mapped to column address 00H and COM0 mapped to row address 00H)

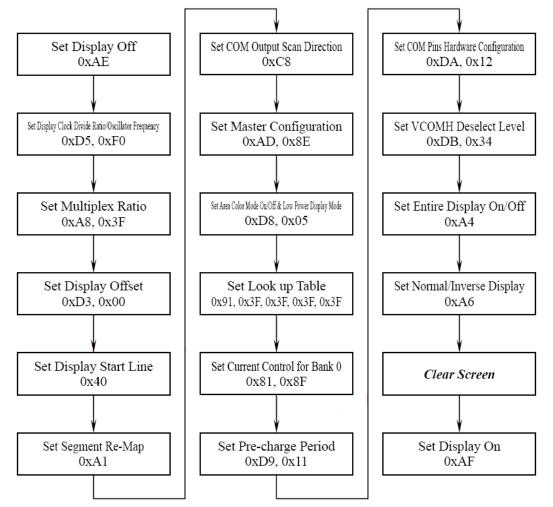
- 4. Shift register data clear in serial interface
- 5. Display start line is set at display RAM address 0
- 6. Column address counter is set at 0
- 7. Normal scan direction of the COM outputs
- 8. Contrast control register is set at 80H
- 9. Normal display mode (Equivalent to A4h command)

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5.4 ACTUAL APPLICATION EXAMPLE

Command usage and explanation of an actual example

<Initialisation Setting>

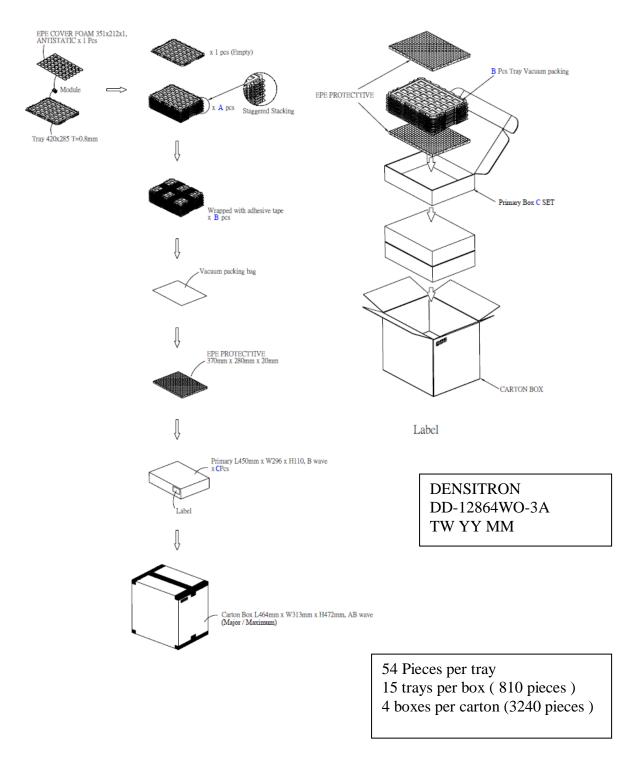


If the noise is accidentally occurred at the displaying window during the operation, please reset the display in order to recover the display function.

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6 PACKAGING AND LABELLING SPECIFICATION



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7 QUALITY ASSURANCE SPECIFICATION

7.1 CONFORMITY

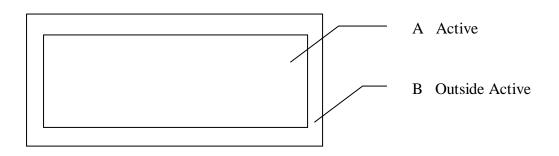
The performance, function and reliability of the shipped products conform to the Product Specification.

7.2 DELIVERY ASSURANCE

7.2.1 DELIVERY INSPECTION STANDARDS

IPC-AA610, class 2 electronic assemblies standard

7.2.2 Zone definition



7.2.3 Visual inspection

Test and measurement to be conducted under following conditions :

Temperature:	23±5°C
Humidity:	55±15%RH
Fluorescent lamp:	30 W
Distance between the Panel & Eyes of the Inspector:	≧30cm
Distance between the Panel & the lamp:	≧50cm

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7.2.4 Standard of appearance inspection

Units: mm

Onits: In				<u> </u>				
Class	Item	Criteria						
Minor	Packing &	Outside & inside package Presence of product no., lot no., quantity						
Critical	Label			ed with others and	quantity must not	be different from		
		that indicated						
Major	Dimension	Product dime	ensions must	be according to sp	pecification and di	rawing		
Major	Electrical	Product elect	trical charact	teristics must be ac	cording to specifi	cation		
Critical	OLED Display	Missing lines allowed	s, short circu	its or wrong patter	rns on OLED disp	lay are not		
Minor	Black spot, white spot,	Round type: $\emptyset = (X+Y)/2$	-	ving drawing				
	dust			А	cceptable quantity	/		
				Size	Zone A	Zone B		
		+	<u>, </u>	Ø<0.1	Any number			
			Y	0.1<Ø<0.2	3	A		
				0.2<Ø<0.25	1	Any number		
		X		0.25<Ø	0			
		Line type: as	per followir	<u> </u>	ble quantity			
		, ^W	Length	Width	Zone A	Zone B		
				W≤0.05	Any number			
			L≤2.0	W≤0.1	3	Any number		
			L>2.0		0			
			Total accep	table quantity: 3				
Minor	Polariser	<u> </u>		n is permitted				
	scratch	Scratch on pe		e as No. 1				
Minor	Polariser	$\emptyset = (X+Y)/2$	2					
	bubble				cceptable quantity			
				Size	Zone A	Zone B		
		+	<u> </u>	Ø<0.5	Any number	Any number		
			-Y	Ø>0.5	0	2		
		X						

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Class	Item	Criteri	a	
Minor	Segment	1b. Pin hole on dot matrix display		
	deformation	₩ < <u>0.05</u>	Acceptable	e quantity
			Size	
			a,b<0.1	Any number
			(a+b)/2≤0.1	Any number
			0.5<Ø<1.0	3
			Total acceptable	quantity: 7
		2. Segments / dots with different width		
			Accep	table
			a≥b	a/b≤4/3
			a <b< td=""><td>a/b>4/3</td></b<>	a/b>4/3
		3. Alignment layer defect $\emptyset = (a+b)/2$	Acceptable Size ∅≤0.4 0.4<∅≤1.0	e quantity Any number 5
			1.0<∅≤1.5	3
			1.5<Ø≤2.0	2
			Total acceptable	
Minor	Panel Chipping	$\begin{array}{c} X \leq 1/6 \text{ Panel length} \\ Y \leq 1 \\ Z \leq T \end{array}$		Z
Minor	Panel Cracking	Cracks not allowed		
Minor	Cupper exposed (pin or film)	Not allowed if visible by eye inspection		
Minor	Film or Trace Damage	Not allowed if affect electrical function		

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Class	Item		Crit	eria	
Minor	Contact Lead Twist	Not allowed		D. TWISTED LEAD	
Minor	Contact Lead Broken	Not allowed		A. BROKEN LEAD	
Minor	Contact Lead Bent	Not allowed if bent lead causes short circuit	A LEAS SECTING		
		Not allowed if bent extends horizontall more than 50% of its width	7		
Minor	Colour uniformity	Level of sample for	r approval set as limi	it sample	
Major	PCB	No unmelted solde	r paste should be pre	sent on PCB	
Critical			missing solder conne		are not allowed
Minor		-	er balls on PCB are a		
Critical	~-	Short circuits on co	omponents are not all		
Minor	Tray			Size	Quantity
	particles		On tray	Ø<0.2 Ø>0.25	Any number 4
				Ø≥0.25	2
	1		On display	$\frac{2}{L=3}$	

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7.3 DEALING WITH CUSTOMER COMPLAINTS

7.3.1 Non-conforming analysis

Purchaser should supply Densitron with detailed data of non-conforming sample. After accepting it, Densitron should complete the analysis in two weeks from receiving the sample.

If the analysis cannot be completed on time, Densitron must inform the purchaser.

7.3.2 Handling of non-conforming displays

If any non-conforming displays are found during customer acceptance inspection which Densitron is clearly responsible for, return them to Densitron.

Both Densitron and customer should analyse the reason and discuss the handling of nonconforming displays when the reason is not clear.

Equally, both sides should discuss and come to agreement for issues pertaining to modification of Densitron quality assurance standard.

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8 RELIABILITY SPECIFICATION

8.1 RELIABILITY TESTS

Test Item	Test Condition	Evaluation and assessment
High Temperature Operation	70°C, 240 hours	No abnormalities in function and appearance
Low Temperature Operation	-30°C, 240 hours	No abnormalities in function and appearance
High Temperature Storage	85°C, 240 hours	No abnormalities in function and appearance
Low Temperature Storage	-40°C, 240 hours	No abnormalities in function and appearance
High Temperature & High Humidity Storage	60°C, 90%RH, 120 hours	No abnormalities in function and appearance
Thermal Shock	24 cycle of -40°C 1 Hour, 85°C 1 Hour. 60 Mins dwell	No abnormalities in function and appearance

• The samples used for above tests do not include polarizer.

• No moisture condensation is observed during tests.

8.1.1 FAILURE CHECK STANDARD

After the completion of the described reliability test, the samples were left at room temperature for 2 hrs prior to conducting the failure teat at 23 ± 5 °C; $55\pm15\%$ RH

8.2 LIFE TIME

Item	Description
1	Function, performance, appearance, etc. shall be free from remarkable deterioration more than 8,000 hours under 120 cd/m ² brightness and 50% Checkerboard, humidity (50% RH), and in area not exposed to direct sunlight.
2	End of lifetime is specified as 50% of initial brightness.

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9 HANDLING PRECAUTIONS

Safety

If the panel breaks, be careful not to get the organic substance in your mouth or in your eyes. If the organic substance touches your skin or clothes, wash it off immediately using soap and plenty of water.

Mounting and Design

Place a transparent plate (e.g. acrylic, polycarbonate or glass) on the display surface to protect the display from external pressure. Leave a small gap between the transparent plate and the display surface.

Design the system so that no input signal is given unless the power supply voltage is applied.

Caution during OLED cleaning

Lightly wipe the display surface with a soft cloth soaked with Isopropyl alcohol, Ethyl alcohol or Trichlorotriflorothane.

Do not wipe the display surface with dry or hard materials that will damage the polariser surface. Do not use aromatic solvents (toluene and xylene), or ketonic solvents (ketone and acetone).

Caution against static charge

As the display uses C-MOS LSI drivers, connect any unused input terminal to V_{DD} or V_{SS} . Do not input any signals before power is turned on.

Also, ground your body, work/assembly table and assembly equipment to protect against static electricity.

Packaging

Displays use OLED elements, and must be treated as such. Avoid strong shock and drop from a height.

To prevent displays from degradation, do not operate or store them exposed directly to sunshine or high temperature/humidity.

Caution during operation

It is indispensable to drive the display within the specified voltage limit since excessive voltage shortens its life.

Other Precautions

When a display module is operated for a long of time with fixed pattern may remain as an after image or slight contrast deviation may occur.

Nonetheless, if the operation is interrupted and left unused for a while, normal state can be restored. Also, there will be no problem in the reliability of the module.

Storage

Store the display in a dark place where the temperature is $25^{\circ}C \pm 10^{\circ}C$ and the humidity below 50% RH.

Store the display in a clean environment, free from dust, organic solvents and corrosive gases. Do not crash, shake or jolt the display (including accessories).

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10 SUPPORTED ACCESSORIES

10.1 DUO KIT

Densitron has developed an easy to use yet powerful development and demonstration tool for driving its range of Passive Matrix OLED displays from the USB port of a PC. DUO (Densitron USB OLED) kit is hot pluggable and does not require extra cables or power supply to run, allowing users to be up and running in minutes.

The kit consists of an OLED display with transition Board, USB controller card, mini USB cable and a CD with software application and drivers.



Part number: PDK-N-12864WO-3A

10.2 TRANSITION BOARD CARD

A Transition board card is like a daughterboard which is meant to be a circuit board for connections between the baseboards (DUO).

It has connector pins for interfacing between the display and the baseboards.

It also includes the OLED display.

Part number: PDT-N-12864WO-3A

10.3 CONNECTOR BOARD CARD

A Connector board card is also a daughterboard which is a circuit board for connection between a microprocessor or microcontroller (customer's system). **Part number: EVK-CONNECT-015**

10.4 CONNECTOR

Т	ype: ZIF connection	ctor			
	No. of connections	Pitch (mm)	Manufacturer	Manufacturer part no.	Distributor part no.
	24	0.50	Omron	XF2M-2415-1A	Farnell/1112559 Digikey/ OR721CT-ND

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